

Edge Selection Guide

Intelligence Begins at the Edge

- / Ecosystem Partners
- / Edge Computers Star Selections
- / Software and Security
- / Edge Value Solutions

Visibility

Agility

Scalability

Reliability

Agentic AI

Edge AI



Edge AI
SDK



Robotic
Suite

SQ Manager



ADVANTECH

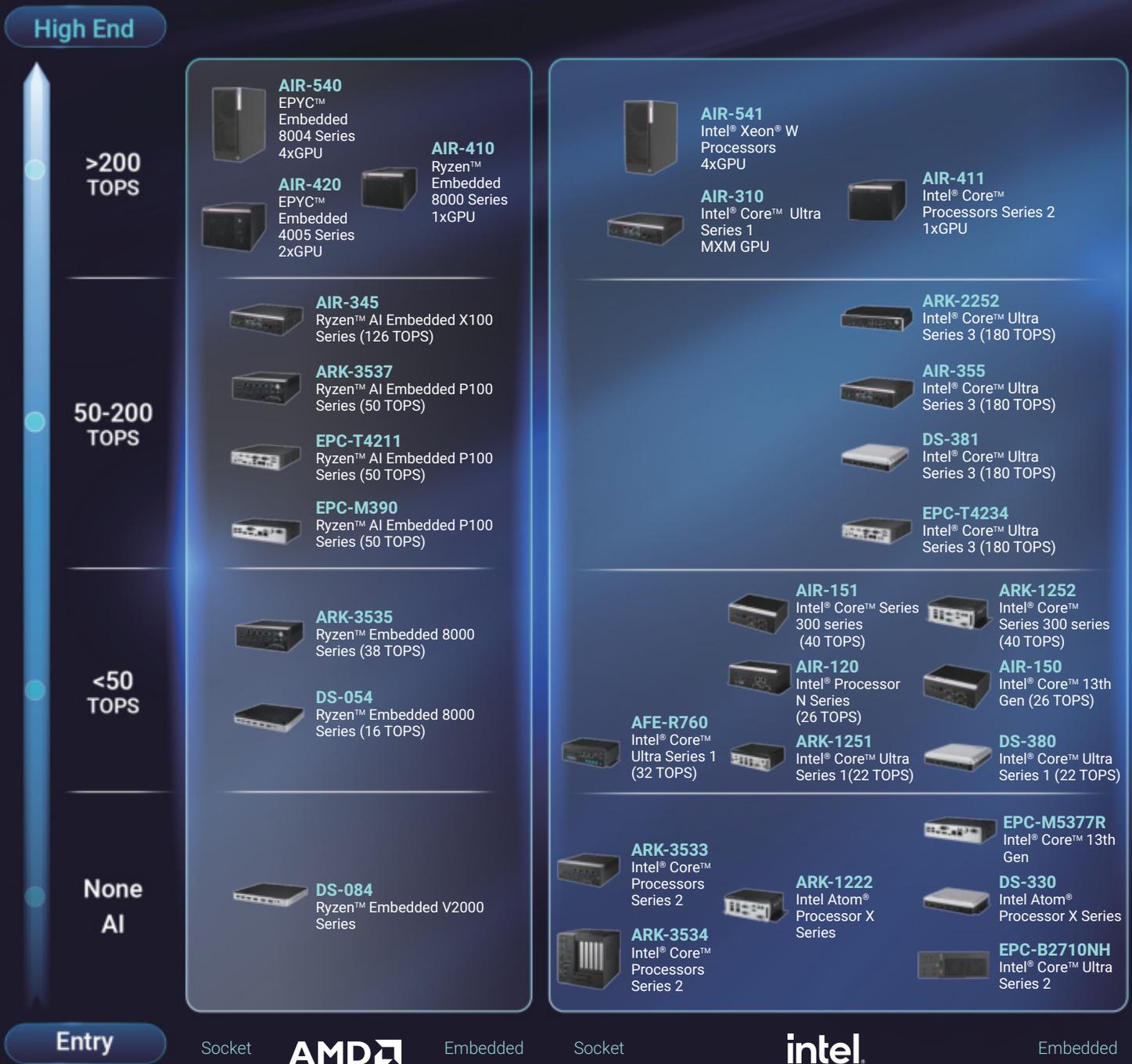
Enabling an Intelligent Planet

www.advantech.com

Scale Beyond Foundations

The Complete Edge AI Journey

Edge AI is revolutionizing industries as the demand for real-time intelligence grows. Advantech leads the way in developing cutting-edge solutions that unlock the full potential of edge computing. Partnering with four key ecosystem leaders, we deliver a complete range of scalable, AI-driven solutions tailored to diverse industry needs. These collaborations ensure seamless integration of hardware, software, and AI tools, accelerating intelligent decision-making at the edge.



AFE

Edge Control and Sensor Fusion
for Autonomous Robots

AIR

Scalable Intelligent Solution.
Ready to Edge AI

EPC

Fast Configuration and
Comprehensive offerings

ARK

From Compact to Powerful -
Empowering Edge Intelligence

DS

Bring Vision AI to
Every Digital Screen Solutions



AIR-055
IQ9075M (100 TOPS)



AFE-A503
IQ9075M (100 TOPS)



AIR-051S
IQ-X (45 TOPS)



AIR-050S
QCS6490 (12 TOPS)



DS-011
QCS6490 (12 TOPS)



AIR-075
NVIDIA® Jetson Thor™



EPC-T5294
NVIDIA Jetson Thor



AFE-A702
NVIDIA Jetson Thor



AIR-030
NVIDIA Jetson AGX
Orin™ (275 TOPS)



AFE-R750-X1/2
NVIDIA Jetson Orin
AGX (275 TOPS)



AFE-R750-M1
NVIDIA Jetson Orin™
NX / Jetson Orin
Nano™ (100 TOPS)



DS-015
NVIDIA Jetson Orin
NX / Jetson Orin Nano
(100 TOPS)



AIR-021
NVIDIA Jetson Orin
NX / Jetson Orin Nano
(100 TOPS)



AIR-020R
NVIDIA Jetson Orin
Nano (67 TOPS)



EPC-R7300
NVIDIA Jetson Orin NX /
Jetson Orin Nano
(100 TOPS)



AIR-020X
NVIDIA Jetson Xavier™ NX
(21 TOPS)



AIR-020N/T
NVIDIA Jetson Nano™ /
Jetson™ TX2 NX
(1.3 TOPS)

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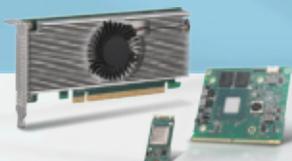
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Industrial Display Solutions



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Vision AI Cameras



Edge AI Solutions

Accelerating AI-Powered Applications



The range of use cases for Edge AI is highly diverse, necessitating varied AI computing capabilities and industrial designs. Advantech collaborates with multiple partners to develop edge AI solutions that integrate hardware and software, facilitating the accelerated deployment of AI across industries such as robotics, smart automation, medical, retail, and smart cities.

AMD intel HAILO

NVIDIA Qualcomm

APPRO ORBEC
Photoelectron

Key Solution Highlights



Application-Oriented

Scalable AI systems for a comprehensive portfolio offering



Vision AI Enabled

Validated 2D / 3D cameras with systems for vision AI solutions



Software Turnkey

No-code GUI & API support to ease the AI application development



Ecosystem Co-creation

Leverage AI ecosystems' add-on value to lower the barrier and shorten deployment time

Solutions Highlights

AI Gateways



AIR-000 Series
Arm SoC Compact Systems

AI Appliance Systems



AIR-100/300 Series
x86 AI Inferencing Systems

Edge AI HPCs



AIR-400/500 Series
Edge HPC w/1-4 GPU Cards



Products

AIR-500 Series

AIR-540


AMD EPYC™ Embedded 8004 Series Edge HPC

- AMD EPYC™ 8004 Series, up to 576GB DDR5
- VGA
- 2x 2.5GbE, 2x 10GbE; USB 3.2 Gen1; COM
- 4x PCIe Gen5 x16 slots (GPU), CXL module
- EDSFF 2C, NVMe: 2x PCIe Gen4 x4, VGA x1
- 0 ~ 40°C, 100~240V, 438 x 440 x 183mm, Weight TBD

AIR-520


AMD EPYC™ Embedded 7003 Series Edge HPC

- AMD EPYC™ 7313P / 7543P / 7713P, up to 768GB DDR4
- VGA
- 2x 2.5GbE, 2x 10GbE, 4x USB3.2, COM, GPIO
- 6x 2.5" SSD, M.2 NVMe, 4x PCIe 4.0 x16 for GPU, VGA via BMC
- 0 ~ 40°C, 100~240V, 380 x 176 x 467mm, 15.5 kg

AIR-510


Intel® Core™ 12~14th Gen Edge HPC

- Intel® 12~14th Gen LGA Socket, up to 192GB DDR5
- 2xDP, HDMI
- GbE, 2.5GbE, 3x USB3.2, 6x COM, GPIO, Audio
- PCIe Gen4 x4, PCIe Gen3x4, 8x 2.5" SSD, M.2 NVMe
- 0 ~ 40°C, 100~240V, 380 x 176 x 467mm, 11 kg

AIR-400 Series

AIR-420


AMD EPYC™ Embedded 4005 Series & Ryzen™ Embedded 7000/9000 Series Edge HPC

- AMD EPYC™ 4005 & Ryzen™ 7000/9000 Series, up to 192GB DDR5
- 4x HDMI
- 2x 2.5GbE, 10GbE, USB: Type-C, 4x USB3.2, 2x USB2.0, 2x COM
- M.2 M-Key, M.2 E-Key, 2x 2.5" SSD, PCIe Gen5 x16/x8 for GPU, 2x PCIe Gen4 x4
- 0 ~ 50°C, 100~240V, 278 x 215 x 480mm, 15.5 kg

AIR-411


Intel® Core™ Processors Series 2 Edge HPC

- Intel® Core™ Processors Series 2, up to 96GB DDR5 5600
- 2x DP, HDMI
- 2x 2.5GbE, USB: 2x USB3.2 Gen2, 2x USB3.2 Gen1, 2x COM, Audio
- PCIe16 Gen4, 2GbE (max. 2.5G)
- 0 ~ 45°C, 100~240V, 240 x 190 x 381mm, 6.9 kg

AIR-410


AMD Ryzen™ Embedded 8000 Series Edge HPC

- AMD Ryzen™ 7 PRO 8845HS / Ryzen™ 5 PRO 8645HS, up to 96GB DDR5
- HDMI, DP
- 3x 2.5GbE, 4x USB3.2, 2x USB2.0, 4x COM, GPIO, Audio
- PCIe16 Gen4 (x8 Signal), M.2 M-Key (PCIe Gen4), M.2 B-Key, M.2 E-Key, 2x 2.5" SSD
- 0 ~ 45°C, 100~240V, 240 x 190 x 381mm, 6.9 kg

AIR-100/300 Series

AIR-310


Intel® Core™ Ultra Series 1 Edge AI System

- Intel® 12~14th Gen LGA Socket, up to 64GB DDR5
- DP1.4a, HDMI 2.0, MXM 3.1 Type A slot
- GbE, 2x 2.5GbE, 4x USB3.2, 2x COM, GPIO, CANBus x2, Audio
- 2x M.2, SSD opt.
- -20 ~ 55°C, 12~24V, 215 x 225 x 55mm, 2.5 kg

AIR-150


Intel® Core™ 13th Gen Edge AI System

- Intel® 13th Gen LGA Socket, up to 64GB DDR5
- 2x HDMI 2.0
- 2x GbE, 3x USB3.0, 1x USB 2.0, 3x COM, GPIO
- 3x M.2, SSD opt.
- -20 ~ 60 °C, 12~24V, 156 x 60 x 112mm, 1.3 kg

AIR-120


Intel® Processor N Series Edge AI System

- Intel® Processor N Series, up to 16GB DDR5
- HDMI 2.0, DP 1.4a
- 2.5GbE, GbE, 2x USB3.2, 2x USB2.0, 2x COM, 2x COM opt., GPIO opt., CANBus x2 opt., Audio
- 3x M.2, SSD opt. SSD(optional)
- -20 ~ 60 °C, 12~24V, 176 x 112 x 66mm, 1.6 kg

AIR-000 Series

AIR-075


NVIDIA® Jetson Thor™

- NVIDIA Jetson Thor, up to 128GB LPDDR5
- HDMI 2.1, DP 1.4a
- 4x 10GbE, 2x USB3.2 Type-C, 2x USB3.2 Gen2 Type-A, Micro-B(RCM only), 2x COM, CANBus x2, GPIO, Audio
- 2x M.2 M Key, 1x M.2 B Key and 1x M.2 E Key support
- -10 ~ 60°C, 12~36 VDC, 236 x 174 x 60mm, Weight TBD

AIR-055


Qualcomm Dragonwing™ IQ-9075

- Qualcomm Kryo Gen 6 SoC, up to 36GB DDR5
- 2x HDMI 1.4, 2x DP 1.4
- 2x 2.5GbE, 2x USB3.2 Type-C, USB3.2 Gen2 Type-A, USB3.2 Gen1 Type-A, 2x USB2.0, 3x COM, CANBus x2, GPIO, Audio
- M.2 3052 B-Key (5G), M.2 2230 E-Key (Wi-Fi/BT), M.2 2280 M-Key (NVMe)
- -20 ~ 60°C, 12~24V, 190 x 174 x 60mm, Weight TBD

AIR-021


NVIDIA® Jetson Orin™ NX/ Orin™ Nano

- NVIDIA Orin NX / Orin Nano, up to 16GB DDR5
- HDMI 2.0b, MIPI over Type-C x2
- 2x GbE (2.5G x1 / 1G x1), 4x USB3.2 Type-A, USB (Only recovery mode) Type-C, 2x COM, GPIO, CANBus
- M.2 3052 B-Key (5G), M.2 2230 E-Key (Wi-Fi/BT), M.2 2280 & 2242 (PCIe), MicroSD
- -20 ~ 55°C, 12~24V, 138 x 110 x 57mm, Weight TBD

Intelligent Edge Computers

Built for the Edge, Design for the Industry

ARK



Advantech ARK Edge Computers engineered for stability, expandability, and security, ARK platforms offer perfect fit I/Os and protocol support, AI-ready computing power add-on, and global certifications. The ARK series ensures reliable performance suited to vertical market applications, accelerating intelligent Edge transformation.



Key Solution Highlights



Pre-Certified Security

IEC 62443-4-2 certified platforms ensure secure, resilient edge computing, regulatory compliance, and minimal downtime



Versatile I/O Expansion

Supports GPU/NPU for scalable Edge AI, with up to 25 I/O connections and 4 PCIe/PCI slots



International Certifications

Certified with CE, FCC, CB, UL, UKCA, CCC, and BSMI, ensuring global compliance and market access

Focused Market Applications



Products



Brochure

The ARK Series is designed for manufacturing, automation, energy storage, and AIoT, enabling real-time monitoring, AI inference, remote management, robotic arm control, and vision inspection in applications with the full coverage fanless edge computers.

ARK-3000 High Performance Series

ARK-3535



AMD Ryzen™ Embedded 8000 Series Performance Edge Computer

- AMD Ryzen™ 8640U/8845HS, up to 96GB DDR5
- 2x HDMI, Type-C (DP ALT)
- 3x 2.5GbE, GbE, 8x USB, 6x COM, 2x CAN, Audio, 16bit DIO
- M.2 Key B 2280, M.2 Key E 2230, 2x 2.5" SSD
- -40 ~ 50°C, 9 ~ 36 VDC, 200 x 75 x 215mm, 3.2 kg

ARK-3534



Intel® Core™ Processors Series 2 Performance Edge Expandable Computer

- Intel® Core™ Processors Series 2 LGA Socket with H610E/R680E, up to 96GB DDR5
- 2x HDMI, optional DVI-D/DP/HDMI
- 1/3x 2.5GbE, GbE, 8x USB, 6x COM
- 3x 2.5" SSD slot, PCI/PCIe x4/PCIe x16, M.2 Key B, M.2 Key E
- -20 ~ 60°C, 9 ~ 36 VDC, 156/197.2 x 204 x 230mm, 6.41 kg

ARK-3533



Intel® Core™ Processors Series 2 Performance Edge Computer

- Intel® Core™ Processors Series 2 LGA Socket with H610E, up to 96GB DDR5
- 2x HDMI
- 3x 2.5GbE, GbE, 8x USB, 8x COM, 2x CAN, 16bit GPIO
- M.2 Key B 2280, M.2 Key E 2230
- -20 ~ 60°C, 9 ~ 36 VDC, 200 x 75 x 215mm, 3.2 kg

ARK-2000 Slim and Modular Series

ARK-2252



Intel® Core™ Ultra 3 Series Modular Edge Computer

- Intel® PTL-H404/ H484, up to 128GB DDR5
- 2x HDMI, Type-C (ALT)
- 4x GbE, 4x USB3, 2x USB2, USB-C, 6x COM, 2x CAN, GPIO, Audio
- M.2 3052 B-key, M.2 2230 E-key, M.2 2280 M-key, iDoor
- -20 ~ 60°C, 12~24V, 260 x 60 x 145mm, 2.5kg

ARK-2251



Intel® Core™ i3/i5/i7 Modular Edge Computer

- Intel® 13th Gen, up to 64GB DDR5
- 2x HDMI
- 3x GbE, 6x USB3, 6x COM, 2x CAN, GPIO, Audio
- mPCIe, M.2 2230 E-key, M.2 2280 M-key, mSATA (shared with mPCIe), iDoor
- -20 ~ 60°C, 260 x 54 x 140.2mm, 2.3kg

ARK-2232



Intel Atom® E3940 SoC Modular Edge Computer

- Intel Atom® E3940, up to 8GB DDR3L
- VGA, HDMI
- 2x GbE, 2x USB3, 4x USB2, 4x COM, GPIO, Audio
- mPCIe, M.2 2230 E-key, 2.5" SSD, mSATA (shared with mPCIe), iDoor
- -20 ~ 60°C, 260 x 44 x 140.2mm, 1.9kg

ARK-1200 DIN-Rail Series

ARK-1251



Intel® Core™ Ultra Series 1 DIN-Rail Edge Computer

- Intel® Core™ Ultra Series 1, 7-155U, 5-125U, up to 96GB DDR5
- HDMI, DP, CE-RED certified for Wi-Fi
- 3x GbE, 2x USB3, 4x USB2, 4x COM, DIO, Audio
- 3x M.2, iDoor, Optional CANbus
- -20 ~ 60°C, 12~28VDC, 60 x 173x 141mm, 1.5 kg

ARK-1222



Intel Atom® Processor X Series DIN-Rail Edge Computer

- Intel® i3-N305/N97/x7433RE, up to 16GB DDR5, CE-RED certified for Wi-Fi
- 2x HDMI 2.0
- 2x GbE, 2x USB3, 2x USB2, 4x COM, DIO, Audio
- 2x M.2, iDoor, Optional CANbus
- -20 ~ 60°C, 12~28VDC, 60 x 158 x 114mm, 0.94 kg

ARK-1221L



Intel Atom®/Celeron DIN-Rail Edge Computer

- Intel® x6413E/N6210/J6412, up to 32GB DDR4
- HDMI, DP
- 2x GbE, 2x USB3, 2x USB2, 2x COM, DIO, Audio
- 2x M.2, Optional CANbus
- -20 ~ 60°C, 12~28VDC, 60 x 158 x 114mm, 1.05 kg

ARK-1100 Compact Series

ARK-1125H



Intel® Processor N-series Fanless Edge Computer

- Intel® N200, up to 16GB DDR5
- 2x HDMI, CE-RED certified for Wi-Fi / 5G
- 2x GbE, 2xUSB3.2, 2xUSB2, 2x COM, 2xCAN, GPIO, Audio
- M.2 2280 B-key, M.2 2230 E-key
- -30 ~ 60°C, 12V, 133 x 46.4 x 94.2mm, 0.7kg

ARK-1125C



Intel Atom® Processor Fanless Edge Computer

- Intel® x7211E, up to 16GB DDR5
- HDMI
- GbE, 2xUSB3.2, 2xUSB2, 4x COM, GPIO, Audio
- M.2 2280 B-key, M.2 2230 E-key, M.2 2230 E key
- -30 ~ 60°C, 12V, 133 x 46.4 x 94.2mm, 0.7kg

ARK-1124H



Intel Atom® E3940 Fanless Edge Computer

- Intel Atom® E3940, up to 8GB DDR3L
- 2x HDMI
- 2x GbE, 4xUSB3.0, COM, Audio
- M.2 2230 E-key, 2.5" SSD, PCIe/mSATA, iDoor
- -20~60°C, 12V, 133 x 46.4 x 94.2mm, 0.7kg

ARK-1124C



Intel® Celeron™ Fanless Edge Computer

- Intel® Celeron™ N3350, up to 8GB DDR3L
- VGA
- GbE, 2xUSB3.0, 4x COM, Audio
- 2.5" SSD, PCIe/mSATA, iDoor
- -20~60°C, 12V, 133 x 46.4 x 94.2mm, 0.7kg

Embedded PCs

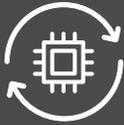
Empowering Edge Computing Innovation and Fast Integration

EPC

From modular boards to intelligent edge computers, EPC empowers industrial PCs with high integration, scalability, and reliability. Designed for flexible adaptation, its solutions fit 3.5", mITX, mATX form factor, both AIMB and MIOe boards. With CPU-to-GPU scalability and standardized chassis design, EPC accelerates edge computing innovation and speed time-to-market.



Key Solution Highlights



Flexible Adaptation

Fits 3.5", mITX, mATX, AIMB, and MIOe boards, effortlessly adapting to diverse hardware configurations and application demands



Scalable Edge Computing

From CPU to GPU, it delivers real-time, high-performance processing to power demanding and data-intensive Edge applications

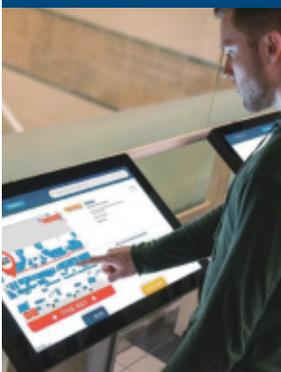


Faster Time-to-Market

Standardized chassis design (1U to 3U+) with streamlined assembly enables rapid system integration and accelerated field deployment

Focused Market Applications

Informative Kiosks



Factory Equipment



Medical Analysis



Self Check-in Kiosks



Products

EPC series enables businesses solutions to market with efficient speed to offer the ready-to-use embedded systems. Its solutions power smart factories with real-time control and predictive maintenance, optimize retail and self-service kiosks for seamless customer engagement, and accelerate medical analysis with fast, precise data processing—delivering scalable, reliable performance across industries.

EPC Performance Series

EPC-B2710NH



Intel Core™ Ultra Series 2 Processors AI System

- Intel® Core™ Ultra Series 2 Processors, up to 96GB DDR5
- HDMI 2.1, DP 1.4
- 2x 2.5GbE, 2x COM, 6x USB3.2, USB4 Type-C, 2x USB2
- 2x 2.5" SSD, x16 PCIe, M.2 E-Key, M.2 M-Key
- 0 ~ 40°C, 12-24V Phoenix or ATX, 275 x 275 x 155mm, 6.5kg

EPC-B3523



AMD Ryzen™ Embedded 7000 Series Performance Edge AI system

- AMD Ryzen™ Embedded 7000 Series processors with B650 chipset, up to 128GB DDR5
- 2x HDMI2.0, DP
- 4x 2.5GbE, 2x 2.5GbE(PoE), 10x COM, 8x USB3.2, USB2
- 3x 2.5" SSD, x16/4/1 PCIe, M.2 M-Key
- 0 ~ 40°C, 500W ATX Power, 360 x 133.4 x 310mm, 9.3kg

EPC-T5294



NVIDIA® Jetson Thor™ AI System

- NVIDIA Jetson T5000 with 14-core Arm® Neoverse®-V3AE 64-bit CPU with 128GB
- HDMI, DP
- 5GbE, QSFP28 (10GbE x4), 2x USB3, 2x USB-C, CANBus, GPIO, 2x COM, 2x GMSL
- M.2 E-Key 2230, M.2 B-Key 3052, M.2 M-Key 2280
- -10 ~ 50°C, 24V, 225 x 174 x 65mm, 3.2 kg

EPC Compact Series

EPC-T4410



AMD Ryzen™ Embedded 7 1U Slim Data Terminal

- AMD Ryzen™ 7 PRO 8840U, up to 96GB DDR5
- HDMI, DP
- 3x GbE, 4x USB3, 2x USB2, 2x COM, Audio (Mic-in, Line-out)
- M.2 E-Key 2230, M.2 B-Key 2242, M.2 M-Key 2280, x8 PCIe
- 0 ~ 45°C, 12-24 VDC, 188 x 44.2 x 188mm, 2.8 kg (6.17 lb)

EPC-T4293A



Qualcomm Platform 1U Box PC

- Qualcomm Snapdragon IQ-X up to 64GB LPDDR5
- 2x DP
- 3x GbE, 4x USB3, 2x USB2, 1x USB-C, 1x GPIO, Audio (Mic-in, Line-out)
- M.2 E-Key 2230, M.2 B-Key 3052, M.2 Key M 2280
- 0 ~ 45°C, 12-24VDC, 188x44.2x125 mm, 2.8 kg (6.17 lb)

EPC-T428A



Intel® 14th Gen 1U Slim Box PC

- Intel® 14th Gen. Core™ i5-14500T, up to 64GB DDR5
- 2x HDMI
- 2x GbE, 4x USB3, 2x USB2, 2x COM, GPIO, Audio (Mic-in, Line-out)
- M.2 Key M 2280
- 0 ~ 45°C, 12 VDC, 188 x 44.2 x 188mm, 2.8 kg (6.17 lb)

EPC-T4219



Intel Atom® 1U Edge Computer

- Intel Atom® X7433RE, up to 16GB DDR4
- HDMI, DP
- 2x GbE, 4x USB3, 2x USB2, 2x COM, USB-C, GPIO, Audio (Mic-in, Line-out)
- 1x 2.5" SSD, M.2 B-Key 2242
- 0 ~ 45°C, 12VDC, 188 x 44.2 x 188mm, 2.8 kg (6.17 lb)

EPC-T4210



AMD Ryzen™ Embedded 7 1U Slim Media Box PC

- AMD Ryzen™ 7 PRO 8840U, up to 96GB DDR5
- 4x DP
- 2x GbE, 4x USB3, 2x USB2, 2x COM, Audio (Mic-in, Line-out)
- M.2 E-Key 2230, M.2 M-Key 2280, PCIe x8
- 0 ~ 45°C, 12-24 VDC, 188 x 44.2 x 188mm, 2.8 kg (6.17 lb)

EPC-T2292A



Intel® 14th Gen with MXM 1U Box PC

- Intel® 14th Gen i9-14900, up to 96GB DDR5
- Quadro® A4500 / Quadro® 5000 Ada
- 2x GbE, 4x USB3, 2x USB2, 2x COM, Audio (Mic-in, Line-out)
- M.2 E-Key 2230, M.2 B-Key 3042, M.2 M-Key 2280
- 0 ~ 45°C, 12-24VDC, 188x44.2x125 mm, 2.8 kg (6.17 lb)

EPC-M5377R



Intel® 13th Gen Power 1U Box PC

- Intel® 13th Gen i7-1370PE, up to 64GB
- HDMI, DP, USB-C DP
- 2x GbE, 4x USB3, 2x USB2, USB-C, 3x COM, Audio (Mic-in, Line-out)
- M.2 E-Key 2230, M.2 B-Key 3052, M.2 M-Key 2280
- 0 ~ 45°C, 12-24VDC, 188 x 44.2 x 125mm, 2.8 kg (6.17 lb)

Robotics Solutions

Dedicated Design for Next-Gen Automation & Robotics



Advantech AS&R series designed with a focus on seamless robotic integration, our industrial computers deliver robust, high-performance solutions that drive efficiency and precision on the factory floor.



Key Solution Highlights



Scalable Platforms

Supporting Intel, Nvidia, Qualcomm and Rockchip solutions with consistent form-factors



Modularized Solution

Chassis, cooler & camera daughter boards, 4/8 GMSL and future MIPI A-PHY, FPD-Link, GMSL3 extension boards for choice



Robotic Suite

Advantech Robotic development solution + optimized platform SDK, library and utility for SLAM, localization, navigation and perception



Integrated Sensor Solutions

Co-developed with sensor partner, leveraging LiDAR, camera, IMU and software vendors to provide easy integrated solution

Focused Market Applications



Basic Navigation and Path Planning



Multi-Robot Fleet Collaboration



Unpredictable Obstacles and Dynamic Paths



Products

AMR Control System

AFE-A702



NVIDIA® Jetson Thor™

- NVIDIA Jetson Thor, 14-core Arm Neoverse V3AE, up to 128GB LPDDR5
- HDMI2.0
- 6x USB3.2, 6x GbE, 2x COM, isolated CANBus x2, isolated DIO 16-bit
- M.2 3052 B-Key (5G), M.2 2230 E-Key (Wi-Fi/BT), M.2 M K-Key 2280 & 2242 (NVMe), 8x FAKRA
- -15 ~ 60°C, 20~28 VDC, 177 x 174 x 90mm, Weight TBD

AFE-R750



NVIDIA® Jetson Orin™ NX / AGX Orin

- NVIDIA® Jetson Orin™ NX / AGX Orin™, up to 64GB LPDDR5
- HDMI2.0
- 4x 2.5GbE, 4xUSB3, 2x COM, 2x isolated CANFD, isolated DIO8/16-bit, FAN connector
- M.2 E-Key, M.2 B-Key, M.2 M-Key, 4/8x FAKRA, 6/9-axis IMU
- -10 ~ 55°C(NX)/-10 ~ 60°C(AGX), 20 ~ 28 VDC, 177 x 174 x 60 mm(NX)/177 x 174 x 80mm(AGX), 1.83(NX)/2.66(AGX) kg

AFE-R770



Intel® 12/13/14th Gen Core™ i3/i5/i7/i9

- Intel® 12/13/14th Gen LGA Socket with R680E or H610E, up to 64GB DDR5
- HDMI1.4
- 4x GbE, 4x USB3, 4x COM, 2x CAN, isolated DIO 8-bit, FAN connector, Audio
- M.2 E-Key, M.2 B-Key, 9-axis IMU
- -20 ~ 70°C, 9 ~ 36 VDC, 200 x 55 x 215mm, 2.7 kg (6 lb)

AFE-R760



Intel® Core™ Ultra Series 1

- Intel® Core™ Ultra Series 1, up to 96GB DDR5
- DP1.4
- 3x 2.5GbE, 2x USB-C, 2x USB-A, 4x COM, 2x CANFD, 8-bit DIO
- M.2 E-Key, M.2 B-Key, 2x M.2 M-Key, 4x FAKRA
- -20 ~ 60°C, 12 ~ 24 VDC, 175 x 60 x 130mm, 1.6 kg (3.5 lb)

AFE-R761



Rockchip RK3588 Cortex®-A76 and A55

- Rockchip RK3588 Arm Quad Cortex-A76 2.4GHz and Quad Cortex-A55 1.8 GHz
- HDMI2.0
- 4x 2.5GbE, 2x USB3.2 & 4xUSB2.0, 2x CAN-FD, 4x RS-485, 8 bit DIO
- M.2 E-Key, M.2 B-Key, M.2 M-Key, 4/6x FAKRA, 4/6x AHD
- -40 ~ 70°C, 12 ~ 24 VDC, 175 x 120 x 56.7mm, 1.6 kg (3.5 lb)

AFE-A503



Qualcomm® Dragon Wing IQ9075M

- Qualcomm® Kryo Gen 6 SoC, up to 32GB LPDDR5
- HDMI1.4
- 4x GbE, 4xUSB, 4COM, 2x CAN FD, 16-bit DIO
- M.2 3052 B-Key (5G), M.2 2230 E-Key (Wi-Fi/BT), M.2 2280 M-Key (NVMe), 8x GMSL FAKRA
- -20 ~ 55°C, 20 ~ 36 VDC, 115 x 165mm (4.5 x 6.5 inches)

Eco Partner Alliance

Open-Source Community

Actively supporting the robotics community by enabling open-source software across diverse CPU platforms, creating reference designs, integrating toolkits with Robotic Suite, and contributing to avant-garde research and prototyping projects.

Domain-Focused SI/ISV

Partnering with prestigious regional robotic software providers to deliver domain-focused, production-ready solutions. These collaborations address customers' system integration needs, based on Advantech's off-the-shelf computing, sensing, and embedded software packages.

Robotic Sensors
Bundled-selling & Co-selling

Collaborating with Tier 1 robotic sensor providers, ensuring that camera, IMU, and other sensors work with various computing platforms. Sensor partners in different regions provide design-in services for robotic manufacturers together with Advantech global teams.

AI-Powered Digital Screen Solutions

Built for Engagement, Designed for Always-On Retail



Advantech Digital Signage (DS) platforms deliver 4K/8K playback, multi-display outputs, validated leading CMS, and device-level security to help retailers, QSRs, transportation hubs, and venues publish the right content at the right time. From ultra-slim Android/Arm players to powerful 4-HDMI x86 systems, the DS series gives you long-life, 24/7 operation and remote fleet management for easy rollouts across hundreds of sites.



Ubuntu



chromeOS



Key Solution Highlights



Slim PC Players

SDM/OPS, Arm/x86 for any display solution



Flawless 4K / Multi-Screen

Reliable 4K, video wall, menu board, and interactive playback



Remote & Secure Management

DeviceOn, CMS integration, fleet-level updates and protection

Focused Market Applications



Advantech DS series is engineered for retail, QSR, hospitality, transportation, entertainment, and corporate communication scenarios. It supports Windows, Android, and modular SDM/OPS formats, and is tightly integrated with DeviceOn and signage CMS to simplify mass deployment, remote diagnosis, and content security. With 24/7 industrial-grade design and worldwide service, Advantech helps customers speed up signage rollouts, lower TCO, and create engaging, data-driven experiences across every screen.



Products



Brochure

DOOH DS-3 Series

DS-380



Outdoor Fanless Intellegent PC

- Intel® Core™ Ultra Series 1 135H, up to 48GB DDR5
- 4x HDMI
- 2x 2.5GbE, 2x USB 3.2 Gen1, 2x USB 2.0, Audio, IR Phone Jack
- M.2 2242 M key, M.2 2230 E key
- -10 ~ 50°C, 19 VDC, 180x177x38 mm, 2 kg (4.4 lb)

DS-330



Book-sized Fanless Outdoor System

- Intel Atom® x7000 series, Processor N series, Core™ i3 N305, up to 16GB DDR5
- 2x HDMI, USB-C
- 2x 2.5GbE, 4x USB 3.2 Gen1, USB-C, Audio, RJ12, 2x RS-232
- M.2 2242 M key, M.2 2230 E key
- -20 ~ 60°C, 12-24 VDC, 180x150x35 mm, 1.27 kg (2.8 lb)

EdgeMount System: DS-5 series

DS-540



VESA Through-Hole PC Designed for Kitchen Display Systems

- Intel® Processor N50, up to 16GB DDR5
- 1 x HDMI 2.1 TMDS, 1 x VGA, 1 x USB-C
- 1 x RJ45, 4 x USB 3.2 Gen1, 1 x USB-C, 2 x RS-232, Audio
- M.2 2242 M key, M.2 2230 E key
- 0 ~ 50°C, 12-24 VDC, 180 x 150 x 35mm, 1kg (2.2lb)

Ultra Slim DS-0 Series

DS-086



8K Ultra-slim Digital Signage Player

- Intel® Core™ Ultra 5 & Ultra 7, up to 48GB DDR5
- 4x HDMI 2.1 8K60/4K60 Ports Support for TV Wall
- RS232, 2x USB 3.2 Gen1, 2x USB 2.0, 2x RJ45
- M.2 2242 M Key, M.2 2230 E Key
- 0 ~ 40°C, 19V DC-in, 180x177x22 mm, 0.9kg (1.98 lb)

DS-084



Ultra-slim 4K Digital Signage Player

- AMD Ryzen™ Embedded R2000 Series, up to 32GB DDR4
- 4x HDMI
- 2x RJ-45, 2x USB 2.0, 2x USB 3.2 Gen1, RS-232, IR, Audio
- M.2 2242 M Key SATA
- 0 ~ 40°C, 19V 3.42A DC-in, 180 x 177 x 23 mm, 0.9kg (1.98 lb)

DS-054



AMD Ryzen™ Embedded 8000 Series Performance Edge Computer

- AMD Ryzen™ 5 PRO 8640U / Ryzen™ 7 PRO 8840U, up to 96GB DDR5
- 4x HDMI, RS-232
- USB 3.2 Gen1, 2x USB2, USB-C
- 2x M.2 2230
- 0 ~ 40°C, 12~ 24 VDC, 180x177x29.9 mm, 0.9kg (1.98 lb)

DS-015



NVIDIA® Jetson Orin™ Nano / NX Compact AI Player

- NVIDIA® Jetson Orin™ Nano/NX, up to 16GB LPDDR5
- HDMI 1.4
- 2x RJ45, 3x USB 3.2 Gen1, USB-C, 2 x RS-232, 2x GMSL, Audio
- M.2 2280 128G, M.2 2230, M.2 2242
- 0 ~ 40°C, 12-24V DC-in, 180x177x29.9 mm, 0.9kg (1.98 lb)

DS-011



Qualcomm® QCS649 Edge-AI Box

- Qualcomm® QCS6490, up to 8GB LPDDR5
- 2x HDMI 2.1 TMDS
- 2x RJ45, 2x USB 3.2 Gen1, 2x RS232, 2x GMSL, Audio
- M.2 2280 M Key, M.2 3042 B Key, M.2 2230 E Key
- 0 ~ 40°C, 12-24V DC-in, 180x177x23 mm, 0.9kg (1.98 lb)

Modular DS-2 Series

DS-230



Smart Display Module

- Intel® 13th Generation Core™ Processor, up to 32GB
- HDMI 2.0 & DP1.4a from golden finger, DP1.4a, M.2 2242/2230
- 2x 2.5GbE, 2 x USB3.2 Gen2
- M.2 2242 M key, M.2 2230 E key
- 0 ~ 55°C, 12 VDC, 175 x 100 x 20 mm, 1kg (2.2 lb)

Mini PC DS-4 Series

DS-410



Atom® J6412 Palm-sized Mini PC

- Stylish Aluminum Die-cast Design with Intel Atom® J6412 processor
- Optimized GFX performance by on board 4GB/8GB DDR4 (3777Mhz)
- Support HDMI 2.0 up to 4K(3840 x 2160), and VGA up to Full HD
- Dual USB 3.0, Dual x Gb LAN, Dual x RS232 via RJ11 ports.
- Support Windows 11 IoT Enterprise LTSC

DS-450

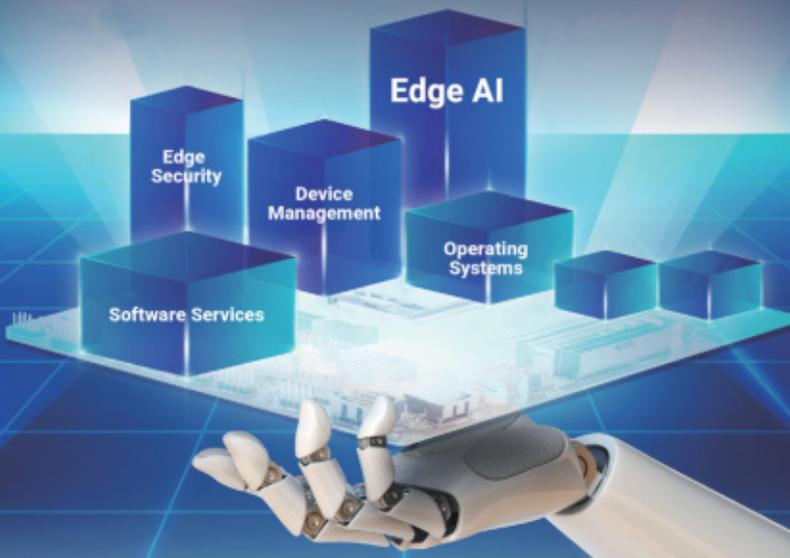


Intel Atom® J6412 Palm-sized Player

- Stylish Aluminum Die-cast Design with Intel Atom® J6412 processor
- Optimized GFX performance by on board 4GB/8GB DDR4 (3777Mhz)
- Support 2 x HDMI up to 4K(3840 x 2160), 6 x USB, 2 x Gb LAN
- 2 x COM, Power on/off, Phoenix connector for device connection via DB9 ports.
- Small system with PWM fan control for silent and smooth fan speed
- Support Windows 11 IoT Enterprise LTSC

Edge Computing & Edge AI Software Solutions

Driving the Future of Edge Intelligence



With the comprehensive software ecosystem designed to empower intelligent edge operations, the solutions integrate foundational software development, device management, and cloud services to address the growing demands of edge AI and diverse industries. Together, these solutions enable streamlined AIoT development, robust edge orchestration, and enhanced AI-powered operations.

Key Solution Highlights



Software Built-in Services

Pre-integrated software and drivers enable faster deployment and seamless hardware compatibility



Modular AI Solutions

Flexible and ready-to-use AI software modules designed to accelerate application development in key verticals



Edge Security Framework

Built-in security frameworks safeguard devices and data through trusted boot, encryption, and advanced threat protection mechanisms

Edge AI Software Portfolio & Services

Edge Operation	Edge Security	Edge AI Development	Edge Management	Edge Deployment Infrastructure	Edge Integration & Service
Operating Systems Ubuntu Pro Windows Windows IoT Enterprise LTSC/ Windows Server IoT	Security Conformity Services 	Generative & Inference AI SDK Edge AI SDK Edge AI Modeling Optimization Platform	Industrial Edge Device Remote Management DeviceOn	Cloud-to-Edge Platform Microsoft Azure Azure IoT Cloud Platform Services	System Integration Ecosystem Partners nagarro
Drivers & API Utility Tools Power Suite SUSI API	Security & Protection Software Trellix Acronis SEC aEDGE	EDGE IMPULSE Large Scale AI Framework NVIDIA NVIDIA Enterprise	Retail, Logistics, Healthcare Mobility Management SOTI	Edge Virtualization & Container Canonical MicroCloud	



Products



Brochure

Advantech delivers edge-to-end software solutions empowering industries to build secure, scalable, and AI-driven systems. Partnering with global leaders like Microsoft, Canonical, NVIDIA, and Qualcomm, we integrate reliable edge operation, AI development, and cloud deployment tools. As an edge AI enabler, Advantech accelerates digital transformation and drives the future of intelligent IoT.

Edge Operation



Advanced Service for 10 Years

- 10-year of security maintenance support
- Kernel Livepatch
- FIPS, Common Criteria, and CIS compliance

Windows IoT

Long-term OS for Fixed IoT Devices

- 10-year support for long-term stability
- Controlled updates with no forced upgrades
- Embedded features with strong security

Windows Server IoT

Enterprise-grade Server OS for IoT

- Full Windows Server for embedded systems
- Long-term stability with fixed lifecycle
- Supports robust security and management



Operating System Enhancement Utility

Multi-OS value-added tools from Advantech for easy deployment

Edge Security



Certified-Ready Security Platform

- Cut compliance costs by 50%
- Recognized by authoritative notified body
- Aim at EU CRA requirement



Security & Regulatory Platform

- Automated firmware and security analysis
- SBOM with vulnerability management
- EU CRA compliance accelerator tool



Reliable App Control for Industry

- Blocks unknown apps with a secure list
- Monitor file integrity and track changes
- Zero-day protection without daily updates



Reliable Backup with Quick Recovery

- Fast image-based backup for any device
- Instant recovery to cut downtime costs
- Active ransomware defense to protect data



Premium TPM Security for Devices

- Crypto-agile trusted security in the TEE
- In-field provisioning with lower BOM cost
- Secure boot, updates, and AI guard

Edge AI Development



Rapid AI SDK Development Toolkit

- Cross-platform inference & benchmarks
- Remote power & OOB control
- Docker container management



Edge AI Model Building Platform

- No-code tools for fast edge AI models
- Optimized workflows for TinyML devices
- Efficient real-time on-device inference



Enterprise AI Software Platform

- Enterprise support and certified HW
- Integrated tools to streamline MLOps
- Unified training and inference stack

Edge Management



AIoT Device Management Platform

- HW/SW monitoring, OTA updates
- Remote power & OOB control
- Docker container management



Enterprise Mobility Management

- Device remote App & content management
- Single sign-on, location & shared device
- SOTI XS analytics & predictive monitoring

Edge Deployment Infrastructure



Connect, Monitor, Analyze IoT

- Safe device links with two-way data
- Scalable edge processing for IoT
- Link Azure services with twins

Industrial Wireless Solutions

Built for AIoT, Designed for Harsh Environments



Advantech Industrial Wireless (AIW) delivers Wi-Fi 5/6/6E/7, 4G LTE, 5G NR, Bluetooth, GNSS, and antennas in industrial form factors to “wireless-enable” embedded and edge devices. Together with AIW design-in and antenna tuning services, OEM/ODM customers can pass global certifications faster and launch connected products for factory, medical, transport, and smart city scenarios.



Key Solution Highlights



Next-Gen Wireless Technologies

Wi-Fi 7, 5G RedCap, LTE Cat.1bis for emerging AIoT



Industrial-Grade & Long Lifecycle

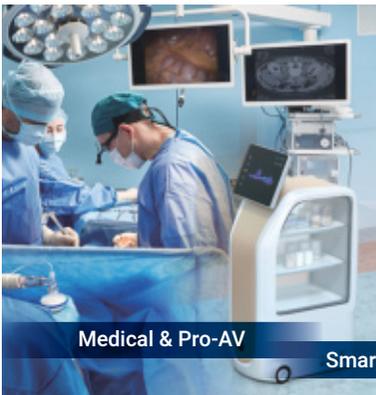
-40~85°C, 5+ year longevity, global radio/EMC certification readiness



Professional Design-In Services

Antenna tuning, RF testing, firmware/driver porting, fast certification support

Focused Market Applications



[Products](#)



[Brochure](#)

Advantech Industrial Wireless (AIW) delivers Wi-Fi 7, 5G/RedCap, LTE, Bluetooth, GNSS, and matching industrial antennas to connect embedded and edge devices. With wide-temperature, long-lifecycle, and global certification-ready modules plus antenna/RF design-in services, AIW helps customers bring reliable, wireless-enabled AIoT equipment to market faster in factories, vehicles, healthcare, and smart city projects.

Wi-Fi Series

AIW-173 Series



Flagship Wi-Fi 7 Industrial-grade solution

- Qualcomm WCN7851
- M.2 2230 E key/ LGA 1620/MiniPCIe
- Windows 11 and Linux support
- Dual band simultaneous support
- -40~85°C



AIW-170BQ



Premium-level Wi-Fi 6E solution

- Qualcomm WCN6856
- M.2 2230 E Key
- Windows 11 and Linux support
- Based on NFA765 reference design
- -40~85°C

AIW-169BR



Entry-level Wi-Fi 6E solution

- Realtek RTL8852CE
- M.2 2230 A/E Key
- Windows 11, Linux and android support
- 6GHz support and compatible with X86 and Arm
- -10~70°C

Wi-Fi Series

EWM-W179M201E



Entry-level Wi-Fi 6 solution

- Realtek RTL8852BE
- M.2 2230 A/E Key
- Windows 11, Linux and android support
- Compatible with X86 and Arm platforms
- 0~70°C

GNSS Series

AIW-212



Standalone Positioning GNSS solution

- ublox NEO-M9N
- Half size mini-PCIe
- Support L1 band
- Windows 11 and Linux
- -40~85°C

AIW-213



Standalone Positioning GNSS solution with dead reckoning

- ublox NEO-M9V
- Half size mini-PCIe
- Support L1 band
- Support multi-mode dead reckoning
- Windows 11 and Linux
- -40~85°C

Cellular Series

AIW-356



5G NR FR1 solution

- Qualcomm SDX62
- M.2 3052 B Key
- Windows 11, Linux Ubuntu 24.04
- US and Japan Carrier certified
- -40~85°C

EWM-341



LTE Cat.6 solution

- Qualcomm SDX12
- M.2 3042 B Key
- Windows 11, Linux Ubuntu 24.04
- US and Japan Carrier certified
- -40~85°C

AIW-344



LTE Cat.4 solution

- Qualcomm MDM9207
- Full-size MiniPCIe
- Windows 10, Linux Ubuntu 20.04
- US and Japan Carrier certified
- -40~85°C

Antennas Series

AIW-512



Entry-level Tri-band Wi-Fi antenna

- 2.4GHz, 5GHz and 6GHz support
- Dipole type
- 0-70°C
- Compatible with AIW-100 series

AIW-520



Industrial-grade GNSS active antenna

- Active antenna with L1 band support
- IP67 compatible
- -40~85°C
- Compatible with AIW-200 series

AIW-534



Industrial-grade Cellular antennas

- LTE band support
- Dipole type
- -40~85°C
- Compatible with EWM-341

Industrial Display Solutions

Sector-Focused Displays, From Design to Deployment

Advantech's industrial display solutions leverage advanced in-house expertise to deliver exceptional quality and flexibility. Spanning the full spectrum from market-ready products to custom design-in services, we provide end-to-end solutions tailored to diverse vertical applications. Our comprehensive product lineup includes Industrial Display Kits, Open Frame and Panel Mount Monitors, Bezelless Series, Curved Monitors, and Digital Signage Displays—all engineered to perform reliably in harsh and demanding environments.



Key Solution Highlights



Optical Bonding

Optically bonded LCDs for sunlight readability - eliminating air gaps, reducing glare, boosting visibility by 400%, and offering anti-moisture, anti-dust, and vandalism resistance



Advanced Display Enhancements

Rugged IP65/67 protection with high-brightness, UV-resistant, anti-reflective display, featuring vandal-resistant cover glass and AG/AR/AF surface coatings



High Brightness for Sunlight Readability

In-house enhanced backlight with thermally optimized low-power design, improved NTSC color and uniformity, auto-dimming via light sensor, plus optional ultra-low dimming down to 2 nits

Focused Market Applications



Products



Download Resources

Advantech delivers tailored solutions for fast-growing markets – from AMR and robotics to medical, outdoor, digital signage, and gaming – powered by the latest display technologies.

Industrial ProFlat Bezeless Monitors

IDP31-215WP



21.5" Industrial IP67-rated Touch Monitor

- 21.5" FHD 1920x1080 resolution
- P-cap touch, multi-touch
- HDMI, USB type A, DC 12V
- 0 ~ 60°C, 529.1 x 325.8 x 48.3mm, 5.7 kg

IDP31-101WP



10.1" Industrial IP67-rated Touch Monitor

- 10.1" WXGA 1280x800 resolution
- P-cap touch, multi-touch
- HDMI, USB type A, DC 12V
- -20 ~ 65°C, 256.9 x 180.6 x 47.3mm, 2.1kg

IDP31-070WP



7" Industrial IP67-rated Touch Monitor

- 7" WVGA 800x480 resolution
- P-cap touch, multi-touch
- HDMI, USB type A, DC 12V
- -20 ~ 65°C, 203 x 142 x 47.1 mm, 1.46 kg

Industrial Touch Monitors

IDP31-238WP



23.8" Industrial IP67-rated Touch Monitor

- 23.8" FHD 1920x1080 resolution
- P-cap touch, multi-touch
- HDMI, USB type A, DC 12V
- 0 ~ 45°C, 580.6 x 350.1 x 50.45mm

IDS-3115



15" XGA Open Frame Touch Monitor

- 15" XGA 1024x768 resolution
- P-cap touch, multi-touch
- VGA, DVI, USB type A, DC 12V
- -20 ~ 60°C, 12 VDC, 344 x 288 x 36.1mm

USB-C Touch Monitors

IDP31-156WC



15.6" Industrial USB-C Touch Monitor

- 15.6" FHD 1920x1080 resolution
- P-cap touch, multi-touch
- USB Type-C, DP, HDMI
- 0 ~ 60°C, 12 VDC, 399.88 x 249.5 x 54 mm

Industrial Display Kits

IDK-1107WP



7" SVGA Touch Display Kit

- 7" 1024x600 resolution
- LVDS interface
- P-cap touch for multi-touch
- AD board for HDMI interface as option

IDK-1110WP



10.1" WXGA Touch Display Kit

- 10.1" 1280x800 resolution
- LVDS interface
- P-cap touch for multi-touch
- AD board for HDMI interface as option

IDK-1113WP



13.3" FHD Touch Display Kit

- 13.3" 1920x1080 resolution
- eDP interface
- P-cap touch with optical bond lamination
- AD board for HDMI interface

Video Wall VWK-9000 Series

VWK-9550



55" Industrial UHD-4K Video-Wall Signage Display

- 4K UHD IPS panel with brilliant color gamut and wide viewing angle
- Video-wall set-up (2 x 2) with large size 110" display advantage
- Multi-signal input and convenient remote Control (HDMI 2.0 x 2, RJ45 x1, RS232 x 1, USB type A x 1)
- Industrial-grade 24/7 operation guarantee
- 0~ 40°C, 110 ~ 240 VAC, 1234.2 x 706.5 x 58.9mm, 12.0 kg (26.46 lb)
- Best Compatible with: DS-086

Edge AI Acceleration Modules

Fast-Track to Edge AI with Efficient Deployment



NPU- and GPU-powered AI acceleration modules offer the fastest and simplest way to integrate AI into current edge computing platforms. These technologies provide advantages in throughput, latency, and efficiency, making them ideal for various AI applications. Advantech partners with leading AI chip providers to deliver cost- and power-efficient acceleration modules in M.2, MXM, and PCIe form factors, ensuring seamless upgrades from edge computing to edge AI.



Key Solution Highlights



Flexibility

Module designs in standard form factors enable quick integration, including M.2, MXM, and PCIe



Diversity

AI computing power ranges from entry-level to high-end, catering to diverse AI applications



Advantech Edge AI SDK

Comprehensive toolset supports rapid edge AI setup and streamlined development workflows

Focused Market Applications

<p>Security Screening</p> <p>EAI-1200</p>	<p>AMR & Robotics</p> <p>EAI-2100</p>	<p>Defect Inspection</p> <p>EAI-3300</p>	<p>Traffic Monitoring</p> <p>EAI-3101</p>
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From entry-level to high-performance, Advantech's EAI Series accelerates the Edge AI journey, with lower costs, faster deployment, and full software support for applications including security screening, traffic monitoring, AMR & Robotics, and defect inspection.



Products



eBook

EAI 1000 (M.2)

EAI-1200

**Hailo-8™ M.2 AI Module B+M-Key**

- Hailo-8™
- M.2 Key B+M 2242
- PCIe Gen3.0x4
- 2242 to 2280 extension bracket
- -40~85°C, 3.3 VDC, 22 x 42 x 2.63mm, 0.025kg

EAI-1200

**Hailo-8™ M.2 AI Module A+E-Key**

- Hailo-8™
- M.2 Key A+E 2230
- PCIe Gen3.0x2
- -40~85°C, 3.3 VDC, 22 x 30 x 2.63mm, 0.024kg

EAI-1961

**DEEPX M.2 AI Module M-Key**

- DEEPX DX-M1
- 2GB LPDDR5*2 (Total 4GB)
- M.2 Key M 2280
- PCIe Gen3.0x4
- -40~85°C, 3.3 VDC, 22 x 80 x 3.8mm, 0.0084kg

EAI-2000 (MXM)

EAI-2100

**Intel® Arc™ A370M GPU MXM Type-A Card**

- GPU: A370M, 4GB
- 4x DP1.4a
- PCIe Gen4.0x8
- Supports optional fansink
- 0-60°C, 3.3 VDC, 82 x 70mm, 0.05kg

EAI-2300

**Hailo-8™ AI MXM Type-A Card**

- Dual Hailo-8™
- MXM Type A
- PCIe Gen3.0x8
- Supports optional fansink
- -40~70°C, 7~20 VDC, 82 x 70mm, 0.03kg

EAI-2841 (Planning)

Upcoming

Axelera MXM Type-A Card

- Metis AIPUx1
- 8GB LPDDR4X (TBD)
- Max. 20-35W (TBD)
- 0-60°C

EAI-3000 (PCIe)

EAI-3100

**Intel® Arc™ A370M GPU PCIe Card**

- GPU: A370M, 4GB
- 2x DP1.4a + 2x HDMI2.0b
- PCIe Gen4.0x8
- 0-60°C, 12 VDC, 168 x 110 x 34.8mm (DualSlot), 0.73kg

EAI-3101

**Intel® Arc™ A380E GPU PCIe Card**

- GPU: A380E, 6GB
- 4x DP1.4a
- PCIe Gen4.0x8
- 0-60°C, 12 VDC, 152 x 110 x 34.8mm (DualSlot), 0.77kg

EAI-3300

**Hailo-8™ AI Acceleration PCIe Card**

- Dual Hailo-8™
- Form Factor: PCIe x16
- PCIe Gen3.0x8
- -40~70°C, 12 VDC, 145 x 68.9 x 18.42mm (Single slot), 0.175kg

EAI-3931

**Intel® Arc™ Pro B60 PCIe Card**

- GPU: B60, 24GB
- 4x DP2.1
- PCIe Gen5.0x8
- 0-45°C, 12 VDC, 289 x 112 x 42mm (DualSlot), 1100g

EAI-3800

**Qualcomm Cloud AI100 Ultra PCIe Card**

- NPU, 870 TOPS
- FH3/4L PCIe x16, single slot
- 128GB LPDDR4x
- Max. 150W

Industrial SSD & Memory Solutions

Pre-Qualified Reliability, First-to-Market Access

Advantech proudly offers its own lines of industrial-grade SSD and DRAM solutions, namely SQFlash and SQRAM, engineered with a strong focus on security and reliability, and fully compatible with all Advantech platforms. Complementing these offerings are extensive customization services and intelligent software tools that enhance usability and performance. Whether for servers, edge devices, or outdoor deployments, SQFlash and SQRAM deliver dependable performance tailored to diverse application needs.



Key Solution Highlights



Ruggedized Design

Built with multi-stage power failure protection and wide temperature operation. Conformal coating and underfill protect against corrosion, humidity, shock, and vibration



Self-Management

Includes DeviceOn/SQ Manager 2.0 for health monitoring, lifespan prediction, remote management, and online predictive maintenance



Flexible Customization

Offers 3-year extended longevity and SPD tuning, with full hardware, software, and firmware support to meet diverse application requirements

Focused Market Applications



[Products](#)



[Brochure](#)

Advantech's SQ solutions provide a comprehensive range of memory products. These solutions support a wide variety of embedded, automation, transportation, and networking applications, as well as data-intensive processing, empowering Edge AI transformation.

SQF PCIe Solution

SQF-C8M 740



M.2 2280 PCIe/NVMe Gen5 x4 SSD

- PCIe Gen5 x4, up to 4TB
- M.2 2280 M key, DRAMLess
- Performance R/W: 10,000/8,000 MB/s
- Support SQ Manager 2.0
- -25~85°C/-40~85°C, 80.0 x 22.0 x 3.8mm, 30g

SQF-C8M 930L



M.2 2280 PCIe/NVMe Gen4 x4 SSD

- PCIe Gen4 x4, up to 1.9TB
- M.2 2280 M key, w/ DRAM
- Performance R/W: 5,500/2,000 MB/s
- Support SQ Manager 2.0
- 0~70°C/-40~85°C, 80.0 x 22.0 x 3.8mm, 35g

SQF-C8M 730



M.2 2280 PCIe/NVMe Gen4 x4 SSD

- PCIe Gen4 x4, up to 4TB
- M.2 2280 M key, DRAMLess
- Performance R/W: 4,900/3,700 MB/s
- Support SQ Manager 2.0
- 0~70°C/-20~85°C/-40~85°C, 80.0 x 22.0 x 3.8mm, 30g

SQF SATA Solution

SQF-C4M 720



M.2 2242 PCIe/NVMe Gen3 x4 SSD

- PCIe Gen3 x4, up to 2TB
- M.2 2242 M key, DRAMLess
- Performance R/W: 2,500/1,950 MB/s
- Support SQ Manager 2.0
- 0~70°C/-20~85°C/-40~85°C, 42.0 x 22.0 x 3.8mm, 25g

SQF-S25 650



2.5" SATA SSD

- SATA 6.0Gbps, up to 2TB
- 2.5" SATA SSD, DRAMLess
- Performance R/W: 558/522 MB/s
- Support SQ Manager 2.0
- 0~70°C/-20~85°C/-40~85°C, 100.0 x 69.9 x 7.0mm, 90g

SQF-S25 840



2.5" SATA SSD

- SATA 6.0Gbps, up to 15.3TB
- 2.5" SATA SSD, w/ DRAM
- Performance R/W: 559/549 MB/s
- Support SQ Manager 2.0
- 0~70°C/-20~85°C/-40~85°C, 100.0 x 69.9 x 7.0mm, 90g

SQF-SMS 650



mSATA SSD

- SATA 6.0Gbps, up to 2TB
- MiniPCIe mSATA, DRAMLess
- Performance R/W: 558/522 MB/s
- Support SQ Manager 2.0
- 0~70°C/-20~85°C/-40~85°C, 50.8 x 30.0 x 4.2mm, 45g

SQF-S8B 650



M.2 2280 SATA SSD

- SATA 6.0Gbps, up to 2TB
- M.2 2280 B+M key, DRAMLess
- Performance R/W: 558/522 MB/s
- Support SQ Manager 2.0
- 0~70°C/-20~85°C/-40~85°C, 80.0 x 22.0 x 3.8mm, 30g

SQR DDR4 Solution

SQR-SD4N



SODIMM 3200

- Up to 32GB
- Downward Compatible 2666
- On-Board EEPROM
- Original Hynix, Micron, Nanya chip
- 0~85°C, 69.60 x 30 x 3.7mm, 9g

SQR DDR5 Solution

SQR-SD5N



SODIMM 5600

- Up to 48GB
- Downward Compatible 4800
- SPD EEPROM Hub and Integrated Thermal Sensor
- Original Hynix IC chip
- 0~95°C, 69.60 x 30 x 3.7mm, 9g

SQR-SD5I



SODIMM 5600

- Up to 32GB
- Support wide temp (-40-95)
- SPD EEPROM Hub and Integrated Thermal Sensor
- Original Hynix IC chip
- -40~95°C, 69.60 x 30 x 3.7 mm, 9g

SQR-SD5N



SODIMM 5600 ECC

- Up to 48GB
- Downward compatible with 4800
- Support ECC& EEPROM Hub & Integrated Thermal Sensor
- Original Hynix IC Chip
- 0~95c, 69.60 x 30 x 3.7mm, 9g

Vision AI Cameras

Intelligent Vision for a Smarter World



The applications of Vision AI Cameras are broad and rapidly expanding, requiring diverse imaging technologies and intelligent processing capabilities. Vision AI cameras that combine advanced optics, AI algorithms, and edge computing enable real-time image recognition, analysis, and decision-making across various industries, including manufacturing, logistics, healthcare, and smart cities.

APPRO
Photoelectron

ORBEC

Key Solution Highlights



2D/3D Solution

Configure settings to suit the actual environment for optimized quality result



Profile Pre-load

Accumulate and save parameter profile, and quickly apply it for a new field fine-tuning



Software Integration

Unified software interface for initial evaluation testing & image application development



System Validation

Reduce evaluation time and accelerate iterative product development

Solution Highlights

2D Device



CAM-2000 Series

2D Long-Distance Device
USB / GMSL interface

3D Device



CAM-5000 Series

3D Depth Sensing Device
USB / GMSL interface

2D / 3D + AI System



CAM-7000 Series

Vision AI All-in-One System
NVIDIA / Qualcomm CPU



[Learn More](#)

CAM-5000 Series

CAM-5530-U



CAM5530 USB3 Stereo Vision Camera

- USB3
- Depth: 1M(1280x800) / 30fps
RGB: 1M(1280x800) / 30fps
- Depth: 94°(H) x 62°(V) ± 3° @ 2m with Global shutter
RGB: 94°(H) x 68°(V) ± 3° with Global shutter
- 124 x 29 x 27.7mm

CAM-5530-G



CAM5530 GMSL2 Stereo Vision Camera

- GMSL2
- Depth: 1M(1280x800) / 30fps
RGB: 1M(1280x800) / 60fps
- Depth: 90°(H) x 65°(V) ± 3° @ 2m with Global shutter
RGB: 94°(H) x 68°(V) ± 3° with Global shutter
- 124 x 29 x 36mm

CAM-5330-U



CAM5330 USB3 Stereo Vision Camera

- USB3
- Depth: 1M(1280x800) / 30fps
RGB: 2M(1920x1080) / 30fps
- Depth: 90°(H) x 65°(V) ± 3° @ 2m with Global shutter
RGB: 86°(H) x 55°(V) ± 3° with Rolling shutter
- 90 x 25 x 30.7mm

CAM-2000 Series

CAM-2210-U



CAM-2210 USB3 Camera

- SONY IMX335 with ISPI5
- USB3
- 5MP(2560x1920) / 30fps
- M12 / F1.6 / 130.7°(D) x 100°(H) x 73.4°(V),
Rolling shutter
- 51.2 x 39.5 x 29mm

CAM-2210-G



CAM-2210 GMSL2 Camera

- SONY IMX335 with ISPI(YUV)
- GMSL2
- 5M(2560x1920) / 30fps
- M12 / F1.6 / 130.7°(D) x 100°(H) x 73.4°(V),
Rolling shutter
- 29 x 39.5 x 54.3mm

CAM-2220-G



CAM-2220 GMSL2 Camera

- ONSEMI AR0234 + ISPI(YUV)
- GMSL2
- 2.3M(1920x1200) / 60fps
- M12 / F1.8 / 113.4°(D) x 95.8°(H) x 59.6°(V),
Global shutter
- 29 x 39.5 x 55.7mm

CAM-2320-G



CAM-2320 GMSL2 Camera

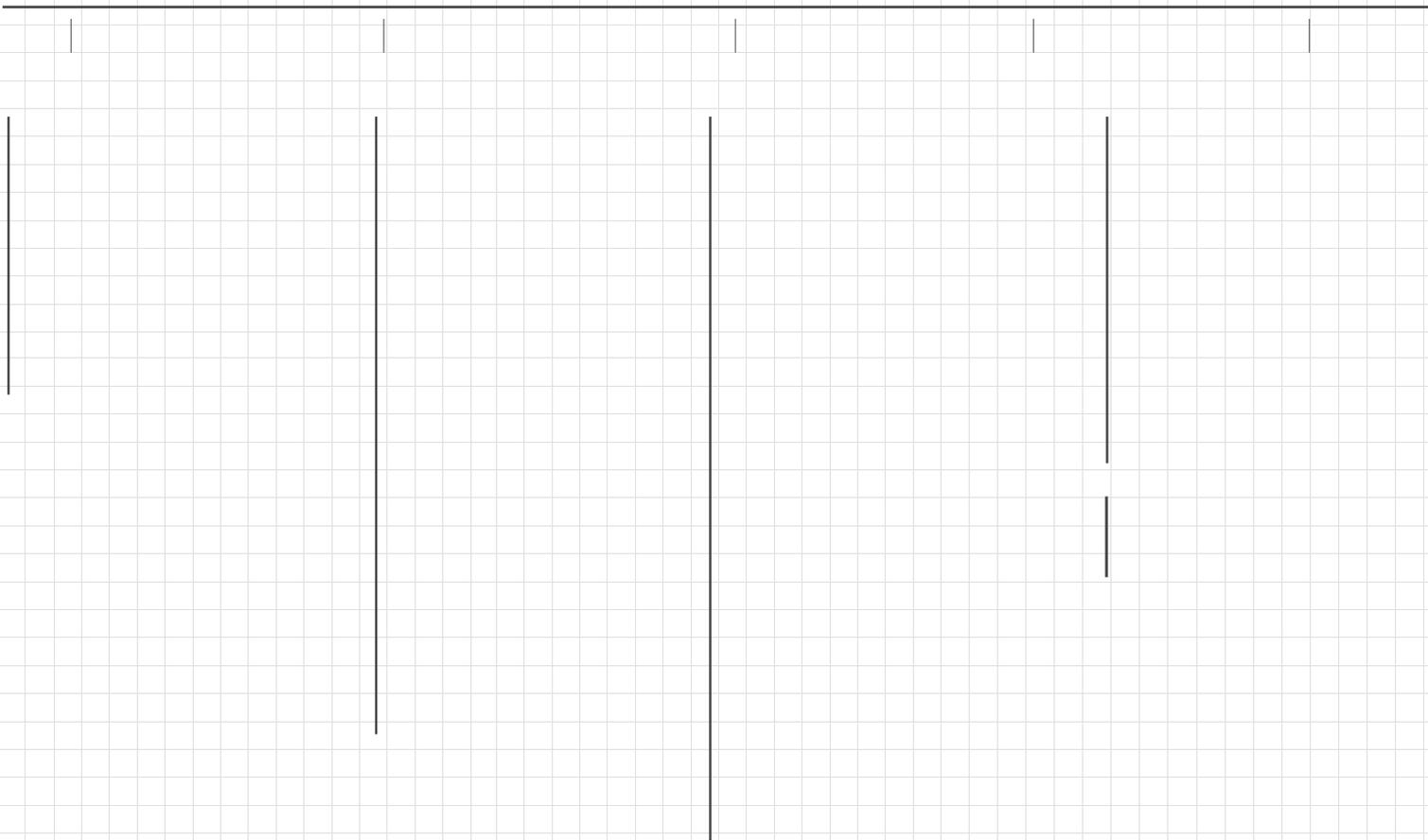
- ONSEMI AR0822+ ISPI(YUV)
- GMSL2
- 4K(3840x2160) / 30fps(4lane)
- M12 / F1.8 / 130°(D) x 112°(H) x 62°(V),
Rolling shutter
- 29 x 39.5 x 56.4mm

CAM-2110-G



CAM-2110 GMSL2 Camera

- SONY IMX290 + ISPI(YUV)
- GMSL2
- 2M(1920x1080) / 60fps
- M12 / F1.8 / 106.6°(D) x 92.6°(H) x 51.8°(V),
Rolling shutter
- 39.5 x 29 x 52.9mm



ADVANTECH

Enabling an Intelligent Planet

www.advantech.com

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